



SEA & LAND ELECTRONIC CORP.

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ALPHA-TOP TECHNOLOGY CORP.

WWW.ALPHA-TOP.CN

APPROVAL SHEET

MODEL NO.:	mSMD300
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CUSTOMER:

CUSTOMER'S APPROVAL:

AUTHORIZED SIGNATURE/STAMP:

DATE

MANUFACTURER:

HEAD OFFICE:

13F.,No.120-10,Sec.3,Zhongshan Rd.,Zhonghe Dist.,New Taipei City 23544,Taiwan
Tel: 886-2-8221-2567
Fax:882-2-2225-7268
E-mail:service@chipfast.com.tw

China Branch:

Factory Building B)Shuangpeng,Weibu Village, Qiuchang Town,
Huiyang District, Huizhou City, Guangdong Province, P.R.C.
Tel: 86-752-3562001
Fax:86-752-3558696
E-mail:service@atptc.com

Submitted by:	Chen
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 Approved by: | YC Lin | DATE: | 3-Mar-25 |

SEA & LAND ELECTRONIC CORP.



mSMD300

Features

- Surface Mount Devices
- Lead free device
- Size 4.5*3.2 mm/0.18*0.12 inch
- Surface Mount packaging
- for automated assembly

Applications

- Almost anywhere there is a low voltage power supply, up to 60V and a load to be protected, including:
- Computer mother board, Modem, USB hub
- PDAs & Charger, Analog & digital line card
- Digital cameras, Disk drives, CD-ROMs,

Alpha-Top (Sea & Land Alliance)

Performance Specification

Model	V _{max} (Vdc)	I _{max} (A)	I _{hold} @25°C (A)	I _{trip} @25°C (A)	P _d Typ. (W)	Maximum Time To Trip		Resistance		Agency Approval	
						Current (A)	Time (Sec)	R _i _{min} (Ω)	R ₁ _{max} (Ω)	UL	TUV
mSMD300	8	100	3.00	5.00	0.8	8.0	4.00	0.012	0.040	✓	✓

I_{hold} = Hold Current. Maximum current device will not trip in 25°C still air.

I_{trip} = Trip Current. Minimum current at which the device will always trip in 25°C still air.

V_{max} = Maximum operating voltage device can withstand without damage at rated current (I_{max}).

I_{max} = Maximum fault current device can withstand without damage at rated voltage (V_{max}).

P_d = Power dissipation when device is in the tripped state in 25°C still air environment at rated voltage.

R_i_{min/max} = Minimum/Maximum device resistance prior to tripping at 25°C.

R₁_{max} = Maximum device resistance is measured one hour post reflow.

CAUTION : Operation beyond the specified ratings may result in damage and possible arcing and flame.

Environmental Specifications

Test	Conditions
Passive aging	+85°C, 1000 hrs.
Humidity aging	+85°C, 85% R.H., 168 hours
Thermal shock	+85°C to -40°C, 20 times
Resistance to solvent	MIL-STD-202, Method 215
Vibration	MIL-STD-202, Method 201
Ambient operating conditions : - 40 °C to +85 °C	
Maximum surface temperature of the device in the tripped state is 125 °C	
In case of special use, please contact our engineer	

Agency Approvals :



E201504(Alpha-Top)/E319079(Sea&Land)



R 50481056

Regulation/Standard:



2015/863/EU



EN14582

I_{hold} Versus Temperature

Model	Maximum ambient operating temperature (T _{max}) vs. hold current (I _{hold})								
	-40°C	-20°C	0°C	25°C	40°C	50°C	60°C	70°C	85°C
mSMD300	4.15	3.76	3.46	3.00	2.55	2.28	2.01	1.61	1.33



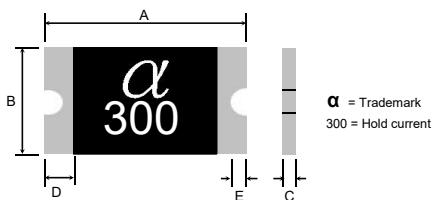
mSMD300

Alpha-Top (Sea & Land Alliance)

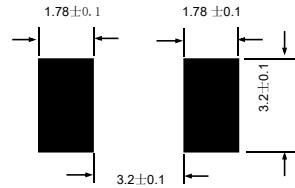
Construction And Dimension (Unit:mm)

Model	A	B	C	D	E	
Min.	Max.	Min.	Max.	Min.	Min.	
mSMD300	4.37	4.73	3.07	3.41	0.50	1.30
					0.30	0.25

Dimensions & Marking



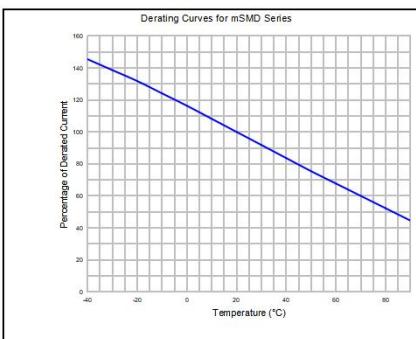
Recommended Pad Layout (mm)



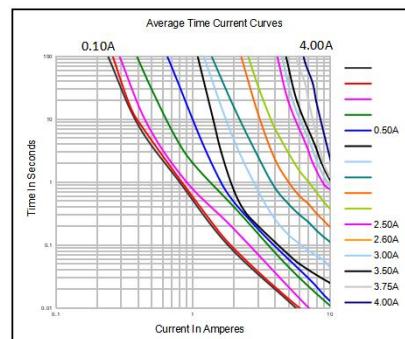
Termination Pad Characteristics

Terminal pad materials: Tin-plated Nickel-Copper
 Terminal pad solderability: Meets EIA specification RS186-9E and ANSI/J-STD-002 Category 3.
Rework
 Use standard industry practices, the removal device must be replaced with a fresh one.

Thermal Derating Curve



Typical Time-To-Trip At 25°C



⚠ WARNING:

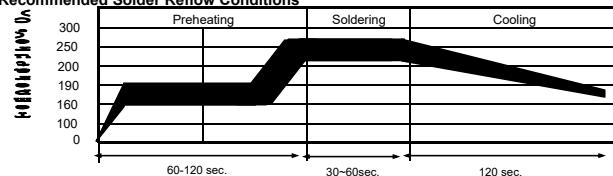
- Use PPTC beyond the maximum ratings or improper use may result in device damage and possible electrical arcing and flame.
- PPTC are intended for protection against occasional over current or over temperature fault conditions and should not be used when repeated fault conditions or prolonged trip events are anticipated.
- Device performance can be impacted negatively if devices are handled in a manner inconsistent with recommended electronic, thermal, and mechanical procedures for electronic components.
- Use PPTC with a large inductance in circuit will generate a circuit voltage ($L \cdot dI/dt$) above the rated voltage of the PPTC.
- Avoid impact PPTC device its thermal expansion like placed under pressure or installed in limited space.
- Contamination of the PPTC material with certain silicon based oils or some aggressive solvents can adversely impact the performance of the devices. PPTC SMD can be cleaned by standard methods.



mSMD300

Alpha-Top (Sea & Land Alliance)

Recommended Solder Reflow Conditions

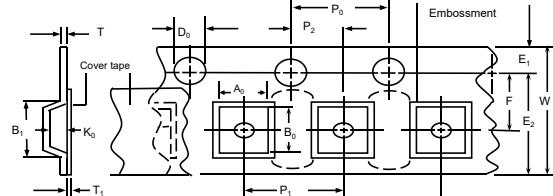


Recommended reflow methods: IR, vapor phase oven, hot air oven.
Devices are not designed to be wave soldered to the bottom side of the board.
Recommended maximum paste thickness is 0.25 mm (0.010 inch).
Devices can be cleaned using standard method and solvents.
Note: If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

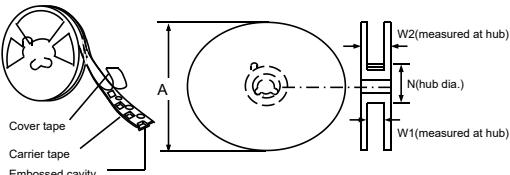
Tape And Reel Specifications (mm)

Governing Specifications	EIA 481-1
W	12 ± 0.3
P0	4.0 ± 0.10
P1	8.0 ± 0.10
P2	2.0 ± 0.05
A0	3.5 ± 0.23
B0	5.1 ± 0.15
B1max.	5.9
D0	1.5 ± 0.1, -0
F	5.5 ± 0.05
E1	1.75 ± 0.10
E2min.	10.25
Tmax.	0.6
T1max.	0.1
K0	0.9 ± 0.15
Leader min.	390
Trailer min.	160
Reel Dimensions	
A max.	178
N min.	60
W1	12.4 + 2.0, -0.0
W2max.	18.4

EIA Tape Component Dimensions



EIA Reel Dimensions



Storage And Handling

- Storage conditions: 40°C max, 70% R.H.
- Devices may not meet specified performance if storage conditions are exceeded.

Order Information

mSMD	300	Packaging
Product name Size 4532mm/1812 inch SMD: surface mount device	Hold Current 3.00A	Tape & Reel Quantity 1,500 pcs/reel

Tape & reel packaging per EIA481-1

Labeling Information

